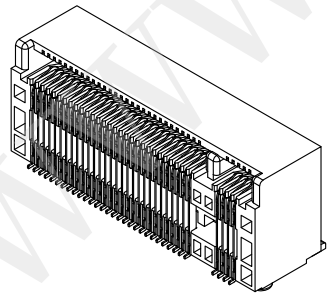
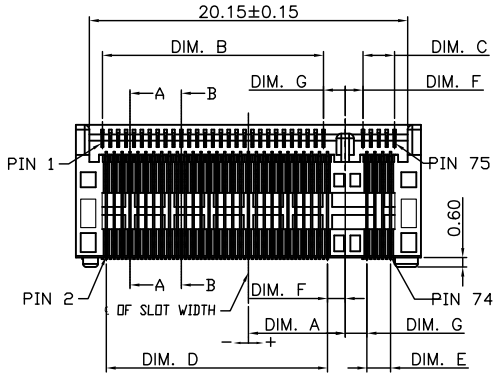
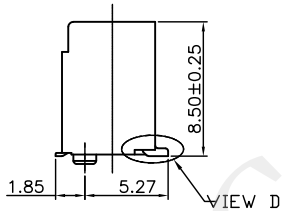


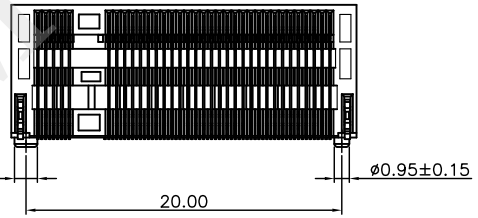


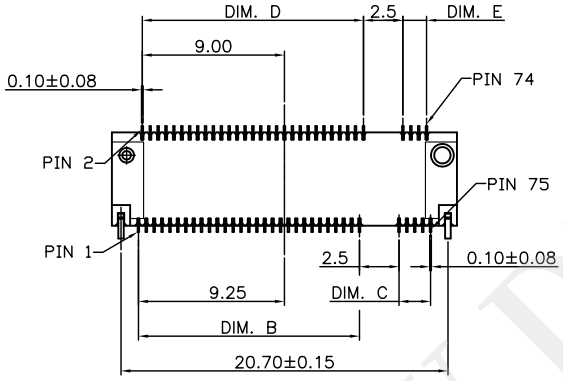
VIEW D
SCALE 4:1

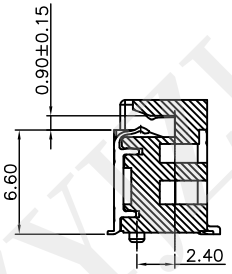




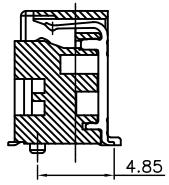




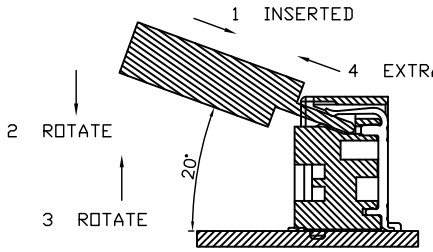




SECTION A-A



SECTION B-B

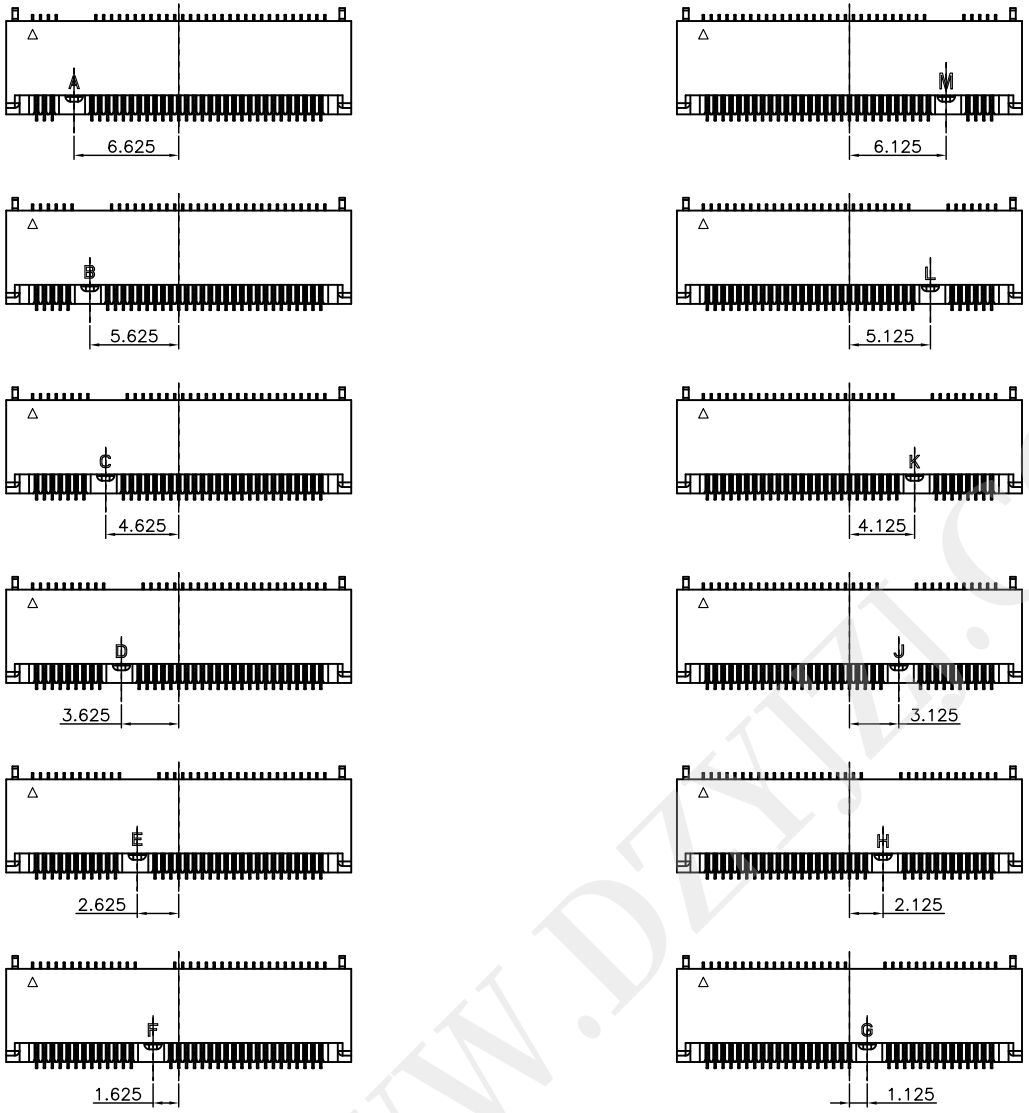


RECOMMENDED OPERATING FLOW:
MATE: 1、2
UNMATE: 3、4

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TOLERANCE: X.X ±0.30, X.XX ±0.25, X.XXX ±0.15, X.° ±2°, X.X° ±0.5°	DRAWED BY : 陈一鸣	DATE : 2014-02-23	PART NAME: NGFF M.2 8.5H 0.5PH
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC58X-05NGFF-850
UNIT: mm [inch]			MOLD NO.
	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2506161024
SCALE:1:1 SIZE: A4			SHEET NO. 1 OF 1

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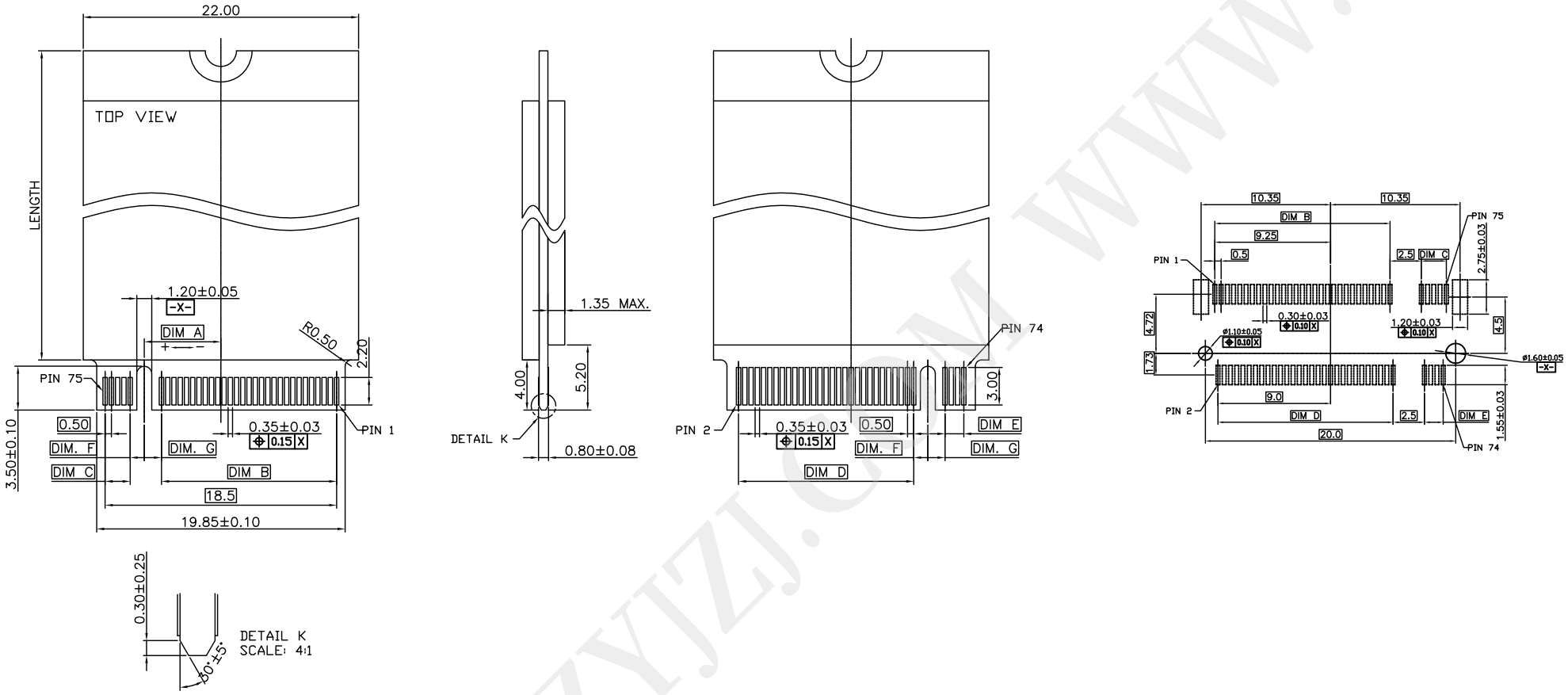
NOTES:

1. MATERIAL :
   - 1.1 HOUSING: THERMOPLASTIC, HIGH TEMPERATURE, UL94 V-0, COLOR: BLACK.
   - 1.2 CONTACT: COPPER ALLOY.
   - 1.3 FITTING NAIL: COPPER ALLOY.
2. FINISH :
   - 2.1 CONTACT
     - [SEE TABLE] GOLD PLATING ON THE CONTACT AREA.
     - GOLD FLASH PLATING ON THE SOLDERING AREA.
     - 1.27um~2.54um [50u"~100u"] MIN. NICKEL UNDERPLATING OVERALL.
   - 2.2 FITTING NAIL
     - 2.54um~5.08um [100u"~200u"] MIN. MATTE-TIN PLATING ON THE SOLDERING AREA.
     - 1.27um~2.54um [50u"~100u"] MIN. NICKEL UNDERPLATING OVERALL.

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SCALE:1:1 SIZE: A4			SHEET NO.	1 OF 1

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1.375	1.125	1.5	14.0	2.0	14.0	6.125	M
1.375	1.125	2.5	13.0	3.0	13.0	5.125	L
1.375	1.125	3.5	12.0	4.0	12.0	4.125	K
1.375	1.125	4.5	11.0	5.0	11.0	3.125	J
1.375	1.125	5.5	10.0	6.0	10.0	2.125	H
1.375	1.125	6.5	9.0	7.0	9.0	1.125	G
DIM. G	DIM. F	DIM. E	DIM. D	DIM. C	DIM. B	DIM. A	KEY ID

1.125	1.375	9.5	6.0	9.5	6.5	-1.625	F
1.125	1.375	10.5	5.0	10.5	5.5	-2.625	E
1.125	1.375	11.5	4.0	11.5	4.5	-3.625	D
1.125	1.375	12.5	3.0	12.5	3.5	-4.625	C
1.125	1.375	13.5	2.0	13.5	2.5	-5.625	B
1.125	1.375	14.5	1.0	14.5	1.5	-6.625	A
DIM. G	DIM. F	DIM. E	DIM. D	DIM. C	DIM. B	DIM. A	KEY ID

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SCALE:1:1	SIZE: A4		SHEET NO. 1 OF 1

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